

PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE AMENDMENT TRANSMITTAL LETTER

I hereby certify that this correspondence is being deposited with the U.S. Postal Service as first class mail in an envelope addressed to Commissioner of Patents and Trademarks, Washington, D.C. 20231 on September 10, 2001.

Elizabeth A. Jue
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Applicant : Rong-Fuh Shyu
Application No. : 09/383,150
Filed : August 25, 1999
Title : LEAD FRAME FOR A SEMICONDUCTOR CHIP PACKAGE, SEMI CONDUCTOR CHIP PACKAGE INCORPORATING MULTIPLE INTEGRATED CIRCUIT CHIPS, AND METHOD OF FABRICATING...
Grp./Div. : 2826
Examiner : F. Abraham
Docket No. : 35761/DBP/S295

Assistant Commissioner for Patents
Washington, D.C. 20231

Post Office Box 7068
Pasadena, CA 91109-7068
September 10, 2001

Enclosed is an amendment to the above-identified application.

CLAIMS AS AMENDED						
	Claims Remaining After Amendment	Highest Number Paid For	Number Extra Claims	Small Entity Rate	Large Entity Rate	FEE
Total Claims Fee	8	* 20		x \$9.00	x \$18.00	
Independent Claims	2	** 3		x \$40.00	x \$80.00	
Multiple Dependent Claims ***				\$135.00	\$270.00	
TOTAL FILING FEE						\$0
NO ADDITIONAL FEE REQUIRED ****	IF NO FEE REQUIRED, INSERT "0"					0
LIST INDEPENDENT CLAIMS: 1, 4						
* IF HIGHEST NUMBER PREVIOUSLY PAID FOR IS 20 OR LESS, WRITE "20" IN COLUMN 3 ** IF HIGHEST NUMBER PREVIOUSLY PAID FOR IS 3 OR LESS, WRITE "3" IN COLUMN 3 *** PAY THIS FEE ONLY WHEN MULTIPLE DEPENDENT CLAIMS ARE ADDED FOR THE FIRST TIME **** IF NO FEE REQUIRED, ADDRESS ENVELOPE TO "BOX NON-FEE AMENDMENTS"						

☐ Attached is our check for \$ to pay the fees calculated above.
☒ A Petition for Extension of Time and the required fee are enclosed.

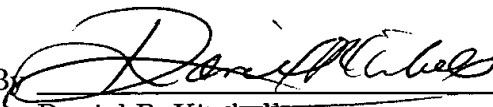
Amendment Transmittal Letter
Application No. 09/383,150

X Other enclosures: Return Postcard

The Commissioner is hereby authorized to charge any fees under 37 CFR 1.16 and 1.17 which may be required by or to give effect to this paper to Deposit Account No. 03-1728. Please show our docket number with any charge or credit to our Deposit Account. **A copy of this letter is enclosed.**

Respectfully submitted,

CHRISTIE, PARKER & HALE, LLP

By 

Daniel R. Kimbell

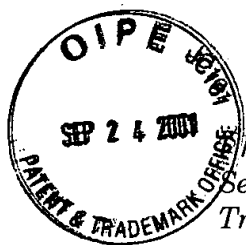
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626/795-9900

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RESPONSE TO OFFICE ACTION

Assistant Commissioner for Patents
Washington, D.C. 20231

Post Office Box 7068
Pasadena, CA 91109-7068
September 10, 2001

Commissioner:

This paper is prepared in response to the Office action of May 9, 2001. Kindly reconsider the rejection of the claims in view of the following remarks.

REMARKS

Claims 1-8 are pending herein.

The Examiner rejects claims 1-8 under 35 U.S.C. 103(a) as being unpatentable over U.S. Patent No. 6,160,312 to Raad in view of the prior art submitted by applicant in Figure 1. Applicant has carefully considered the Examiner's description of the Raad reference and respectfully believes that the cited references fail to teach or suggest the